TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (Ultra High speed U-MOSIII)

TPCA8003-H

High Speed and High Efficiency DC-DC Converters Notebook PC Applications Portable Equipment Applications

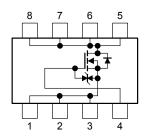
- Small footprint due to small and thin package
- High speed switching
- Small gate charge: $Q_g = 25 \text{ nC (typ.)}$
- Low drain-source ON resistance: RDS (ON) = $5.1 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 60S$ (typ.)
- Low leakage current: $IDSS = 10 \mu A (max) (VDS = 30 V)$
- Enhancement mode: V_{th} = 1.1 to 2.3 V (V_{DS} = 10 V, I_{D} = 1 mA)

Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	30	V	
Drain-gate voltage (R	$k_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	ID	35	Α	
Drain current	Pulsed (Note 1)	I _{DP}	105		
Drain power dissipati	on (Tc=25°C)	P_{D}	45	W	
Drain power dissipati	on $(t = 10 s)$ (Note 2a)	P_{D}	2.8	W	
Drain power dissipati	on (t = 10 s) (Note 2b)	P _D	1.6	W	
Single pulse avalanch	ne energy (Note 3)	EAS	159	mJ	
Avalanche current		I _{AR}	35	Α	
Repetitive avalanche	energy c=25°C) (Note 4)	EAR	4.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55 to 150	°C	

Weight: 0.080 g (typ.)

Circuit Configuration



Note: For (Note 1), (Note 2), (Note 3), (Note 4), please refer to the next page.

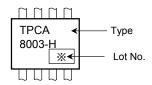
This transistor is an electrostatic sensitive device. Please handle with caution.



Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

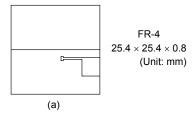
Marking (Note 5)

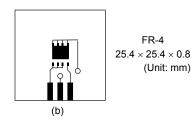


Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)

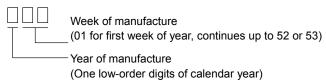




Note 3: $V_{DD}=24~V,~~T_{ch}=25^{\circ}C$ (initial), $L=0.1~mH,~~R_{G}=25~\Omega,~~I_{AR}=35~A$

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: * Weekly code: (Three digits)



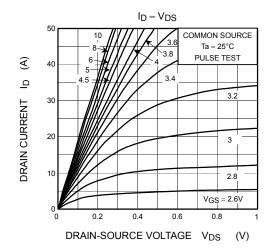
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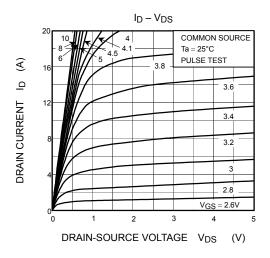
Electrical Characteristics (Ta = 25°C)

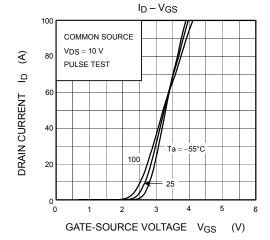
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-OFF cu	rrent	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	10	μА
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_	_	V
Diani-source bre	akuowii voitage	V _{(BR) DSX}	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15 — —		V	
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.1	_	2.3	V
Drain source ON	rociatanas	Dec (cu)	V _{GS} = 4.5 V, I _D = 18 A	_	7.3	9.5	
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 18 A	_	5.1	6.6	mΩ
Forward transfer	Forward transfer admittance		V _{DS} = 10 V, I _D = 18 A	30	60	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	1465	_	pF
Reverse transfer capacitance		C _{rss}		_	175	_	
Output capacitance		Coss		_	610	_	
Switching time	Rise time	t _r	ACS 10 A 10 = 18 Y 10 = 18 Y	_	4	_	- ns
	Turn-ON time	t _{on}		_	11	_	
	Fall time	t _f		_	10	_	
	Turn-OFF time	t _{off}	$V_{DD} \simeq 15 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	36	_	
Total gate charge		Qg	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$	_	25	_	
	te-source plus gate-drain)		$V_{DD} \simeq 24 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 35 \text{ A}$	_	13	_	
Gate-source charge 1		Q _{gs1}	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$	_	5.8	_	nC
Gate-drain ("miller") charge		Q _{gd}		_	5.1	_	
Gate switch charge		Q _{SW}	1		8.4	_	

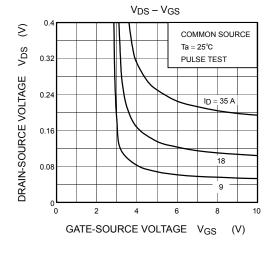
Source-Drain Ratings and Characteristics (Ta = 25°C)

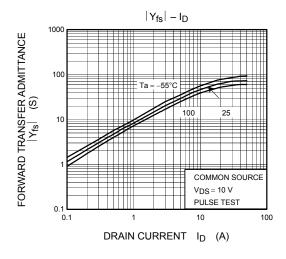
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	105	Α
Forward voltage (diode)			V_{DSF}	$I_{DR} = 35 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.2	V

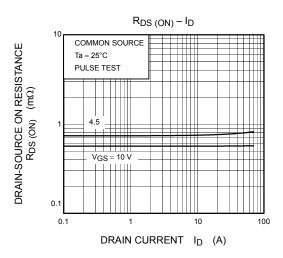


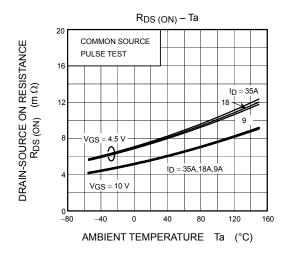


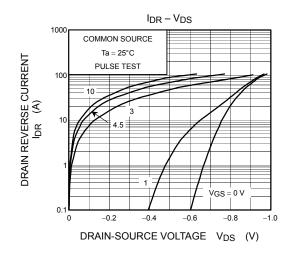


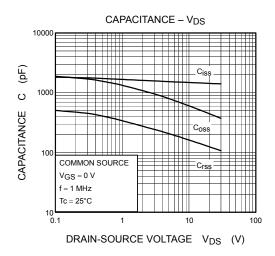


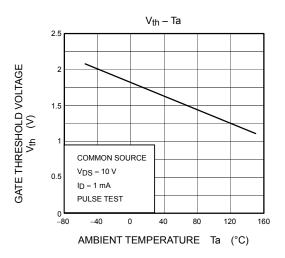


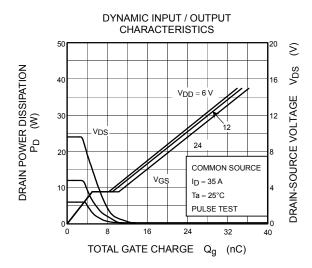




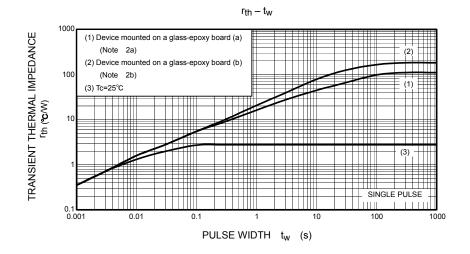


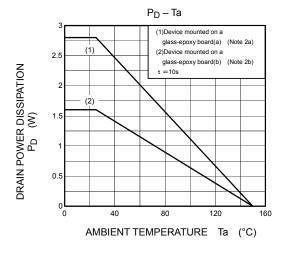


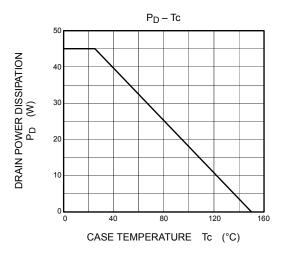


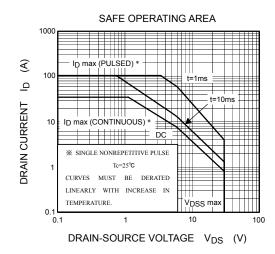


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